Supplier Name: Contact Info: Form/Declaration Type: Created on:

Texas Instruments Inc. (DUNS# 00-732-1904) ti.com/support Distribute - RoHS and IEC 62474 DB

Distribute - RoHS and IE 06/02/2022

Details for "LP2950CZ-3.0/NOPB"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LP2950CZ-3.0/NOPB		Level-NC-NC-NC	Ext-Mfg	LP 3	4.3x4.3x3.6	203.3

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level			
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm		
Bond Wire									
Precious Metals	Gold	7440-57-5	0.048956	100	1000000	0.024086	241		
Sub-Total			0.048956	100	1000000	0.024086	241		
Lead Frame									
Copper and Its Alloys	Copper	7440-50-8	89.883	99.87	998700	44.221422	442214		
Copper and Its Alloys	Iron	7439-89-6	0.09	0.1	1000	0.044279	443		
Copper and Its Alloys	Phosphorus	7723-14-0	0.027	0.03	300	0.013284	133		
Sub-Total			90	100	1000000	44.278985	442790		
Lead Frame Plating									
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.015	100	1000000	0.00738	74		
Sub-Total			0.015	100	1000000	0.00738	74		
Mold Compound									
Other Inorganic Materials	Fused Silica	60676-86-0	22.404478	20	200000	11.022751	110228		
Other Inorganic Materials	Silica	7631-86-9	72.814553	65	650000	35.823939	358239		
Other Nonferrous Metals and Alloys	Metal Hydroxide	Trade Secret	1.680336	1.5	15000	0.826706	8267		
Other Plastics and Rubber	Carbon Black	1333-86-4	0.560112	0.5	5000	0.275569	2756		
Other Plastics and Rubber	Silicone	218163-11-2	7.281455	6.5	65000	3.582394	35824		
Thermoplastics	Epoxy	85954-11-6	7.281455	6.5	65000	3.582394	35824		
Sub-Total			112.022389	100	1000000	55.113752	551138		
Semiconductor Device									
Ceramics / Glass	Doped Silicon	7440-21-3	1.170346	100	1000000	0.575797	5758		
Sub-Total			1.170346	100	1000000	0.575797	5758		
Total			203.256691			100	1000000		

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

Important Part Information

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Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

The bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality

For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/02/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products also fully compliant with ADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.